



CERAMIC

Low Pass Filter

LFCN-3000+

Mini-Circuits

50Ω DC¹ to 3000 MHz

FEATURES

- Excellent power handling, 10W
- Small size
- 7 sections
- Temperature stable
- LTCC construction
- Protected by U.S. Patent 6,943,646



Generic photo used for illustration purposes only

CASE STYLE: FV1206

APPLICATIONS

- Harmonic rejection
- VHF/UHF transmitters/receivers
- Lab use

+RoHS Compliant

The +Suffix identifies RoHS Compliance. See our web site for RoHS Compliance methodologies and qualifications

ELECTRICAL SPECIFICATIONS^{1,2} AT 25°C

Parameter		F#	Frequency (MHz)	Min.	Typ.	Max.	Units
Passband	Insertion Loss	DC-F1	DC-3000	—	—	1.2	dB
	Freq. Cut-Off	F2	3600	—	3.0	—	dB
	VSWR	DC-F1	DC-3000	—	1.2	—	:1
Stop Band	Rejection Loss	F3	4550	20	—	—	dB
		F4-F5	4780-7500	—	30	—	
	VSWR	F6	10000	—	20	—	:1
		F3-F6	4550-10000	—	20	—	

1. In Applications where DC isolation to ground is required, coupling capacitors are recommended to avoid DC leakage. Alternatively, if DC pass IN-OUT is required, Mini-Circuits' "D" suffix version of this model will support DC IN-OUT, and provide >100 MOhm isolation to ground.

2. Measured on Mini-Circuits Characterization Test Board TB-270.

MAXIMUM RATINGS

Parameter	Ratings
Operating temperature	-55°C to 100°C
Storage temperature	-55°C to 100°C
RF Power Input ³	10 W max. at 25°C

3. Passband rating, derate linearly to 3.5W at 100°C ambient. Permanent damage may occur if any of these limits are exceeded.

TYPICAL FREQUENCY RESPONSE



FUNCTIONAL SCHEMATIC



REV. L
ECO-011761
LFCN-3000+
AD/CP/AM
220128





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LFCN-3000+

PIN CONNECTIONS

RF IN	1
RF OUT	3
GROUND	2,4

PRODUCT MARKING: N/A

DEMO BOARD MCL P/N: TB-270
SUGGESTED PCB LAYOUT (PL-137)



- NOTES:**
1. COPLANAR WAVEGUIDE PARAMETERS ARE SHOWN FOR ROGERS RO4350B WITH THICKNESS .020" ± .0015". COPPER: 1/2 OZ. EACH SIDE. FOR OTHER MATERIALS TRACE WIDTH & GAP MAY NEED TO BE MODIFIED.
 2. BOTTOM SIDE OF THE PCB IS CONTINUOUS GROUND PLANE.

- DENOTES PCB COPPER LAYOUT WITH SMOBC (SOLDER MASK OVER BARE COPPER)
- DENOTES COPPER LAND PATTERN FREE OF SOLDER MASK

OUTLINE DRAWING



PCB Land Pattern



Suggested Layout,
Tolerance to be within ±.002

OUTLINE DIMENSIONS (Inches mm)

A	B	C	D	E	F	G
.126	.063	.037	.020	.032	.009	.169
3.20	1.60	0.94	0.51	0.81	0.23	4.29

H	J	K	L	M	N	P	wt
.087	.024	.122	.024	.087	.012	.071	grams
2.21	0.61	3.10	0.61	2.21	0.30	1.80	.020

TAPE & REEL INFORMATION: F71



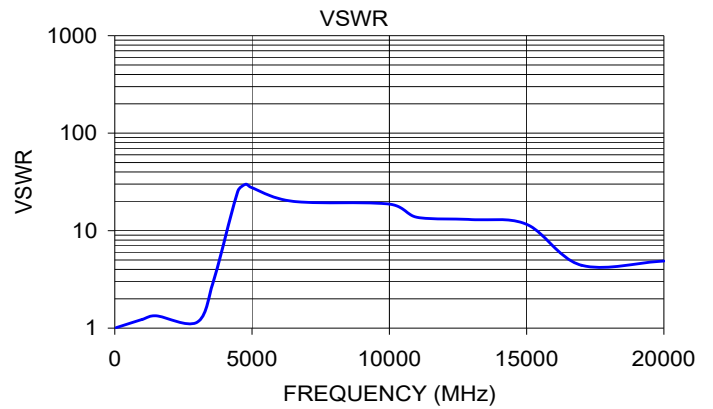
CERAMIC

Low Pass Filter

LFCN-3000+

TYPICAL PERFORMANCE DATA AT 25°C

Frequency (MHz)	Insertion Loss (dB)	VSWR (:1)
50	0.03	1.01
1000	0.29	1.23
1500	0.40	1.34
3000	0.77	1.15
3600	2.96	3.08
4480	25.24	25.19
4780	40.44	29.96
5000	46.26	27.59
6500	36.73	19.98
10000	21.68	18.70
11000	19.41	13.70
13000	13.67	12.99
15000	14.56	11.61
17000	16.94	4.41
20000	24.85	4.88



NOTES

- A. Performance and quality attributes and conditions not expressly stated in this specification document are intended to be excluded and do not form a part of this specification document.
- B. Electrical specifications and performance data contained in this specification document are based on Mini-Circuit's applicable established test performance criteria and measurement instructions.
- C. The parts covered by this specification document are subject to Mini-Circuits standard limited warranty and terms and conditions (collectively, "Standard Terms"); Purchasers of this part are entitled to the rights and benefits contained therein. For a full statement of the standard. Terms and the exclusive rights and remedies thereunder, please visit Mini-Circuits' website at www.minicircuits.com/MCLStore/terms.jsp



Ceramic Low Pass Filter

LFCN-3000+

Typical Performance Data

FREQ. (MHz)	INSERTION LOSS (dB)			INPUT RETURN LOSS (dB)			OUTPUT RETURN LOSS (dB)		
	@ -55° C	@ +25° C	@ +100° C	@ -55° C	@ +25° C	@ +100° C	@ -55° C	@ +25° C	@ +100° C
50	0.06	0.08	0.08	44.91	39.24	35.43	47.95	39.64	35.50
100	0.08	0.09	0.10	39.89	39.89	37.06	41.82	39.92	35.56
500	0.14	0.19	0.23	32.16	30.19	26.92	33.09	30.40	26.96
1000	0.22	0.29	0.34	23.54	22.83	23.16	23.35	22.74	22.88
2000	0.40	0.52	0.61	17.17	17.15	17.02	17.41	17.38	17.28
2500	0.48	0.59	0.70	18.17	19.12	19.50	18.35	19.28	19.61
3000	0.59	0.75	0.90	45.90	42.95	34.73	32.00	30.29	29.08
3240	0.82	1.03	1.23	18.62	17.30	16.43	18.55	17.47	16.76
3580	2.40	2.80	3.21	6.49	6.26	6.07	6.74	6.53	6.29
3600	2.61	3.02	3.45	6.04	5.85	5.67	6.27	6.09	5.87
3720	4.22	4.71	5.23	3.79	3.73	3.67	3.99	3.96	3.86
3940	8.70	9.37	10.08	1.59	1.69	1.76	1.84	1.92	1.96
4120	13.43	14.22	15.04	0.92	1.06	1.17	1.19	1.31	1.41
4280	18.10	19.05	20.03	0.67	0.83	0.95	0.97	1.12	1.25
4350	20.32	21.34	22.38	0.61	0.78	0.90	0.91	1.08	1.22
4410	22.39	23.47	24.53	0.56	0.74	0.86	0.88	1.05	1.20
4530	26.71	27.89	29.10	0.51	0.68	0.81	0.81	1.01	1.20
4550	27.46	28.69	29.93	0.50	0.68	0.81	0.81	1.02	1.21
4710	34.65	36.06	37.62	0.45	0.64	0.76	0.82	1.04	1.24
4780	38.39	39.94	41.67	0.45	0.63	0.76	0.83	1.05	1.26
4910	46.47	48.33	49.33	0.43	0.61	0.73	0.82	1.04	1.27
5020	49.48	48.81	48.39	0.43	0.60	0.72	0.82	1.05	1.28
5450	49.91	50.91	52.11	0.43	0.60	0.72	0.84	1.05	1.23
5900	40.80	40.51	40.51	0.47	0.67	0.82	0.76	0.96	1.08
6410	34.48	34.53	34.08	0.50	0.72	0.96	0.70	0.87	1.01
7000	30.49	30.71	30.30	0.58	0.81	1.07	0.64	0.86	1.06
7500	27.71	27.66	27.72	0.68	0.87	1.07	0.61	0.87	1.11
8000	24.15	24.83	24.69	0.77	0.89	1.06	0.72	0.96	1.24
8500	21.72	22.38	23.15	0.86	0.95	1.05	0.87	1.04	1.27
9000	21.94	21.82	21.90	0.65	0.93	1.10	0.82	1.03	1.26
9500	20.33	19.94	19.78	0.66	1.01	1.22	1.04	1.22	1.36
10000	18.27	18.32	18.23	0.66	1.02	1.26	1.03	1.24	1.30
10500	17.51	17.58	17.26	0.84	1.07	1.32	1.00	1.17	1.24
11000	16.87	17.04	16.95	0.86	1.07	1.26	0.89	1.13	1.21
11500	15.68	16.24	16.32	1.06	1.17	1.27	0.91	1.10	1.21
12000	16.02	16.12	16.35	0.92	1.17	1.39	0.81	1.05	1.21
13000	14.31	13.86	13.71	0.64	1.10	1.54	0.86	1.10	1.33
14000	11.86	12.42	12.57	0.95	1.26	1.76	1.14	1.39	1.68
16000	10.01	10.68	11.39	4.31	4.79	5.42	2.77	2.99	3.29
18000	16.99	18.21	19.77	4.26	4.69	4.96	2.46	2.99	3.24
20000	25.06	25.33	25.98	3.66	4.06	3.99	1.28	1.70	2.19

REV. X1
LFCN-3000+
080722
Page 1 of 1



IF/RF MICROWAVE COMPONENTS • ISO 9001 ISO 14001 AS 9100 CERTIFIED • RoHS compliant
P.O. Box 350166, Brooklyn, New York 11235-0003 (718) 934-4500 Fax (718) 332-4661

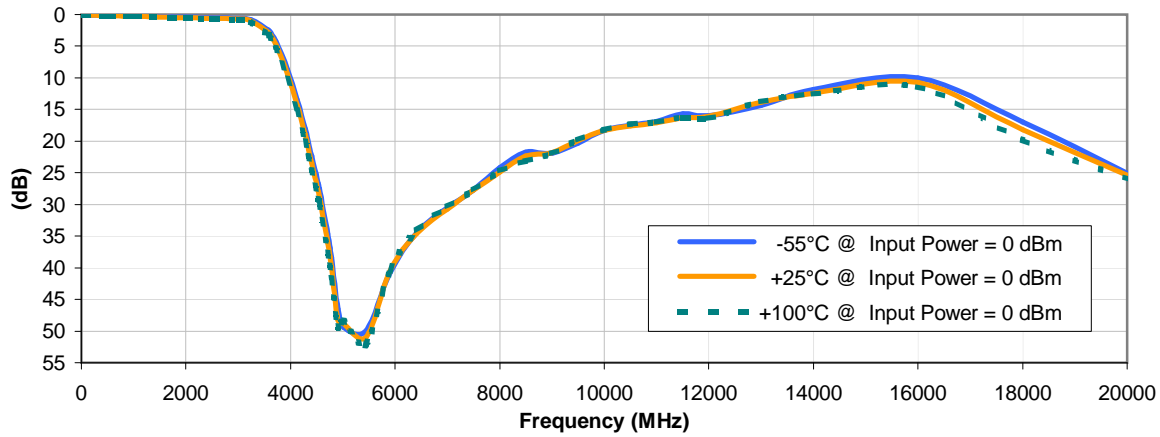


The Design Engineers Search Engine finds the model you need, Instantly • For detailed performance specs & shopping online see

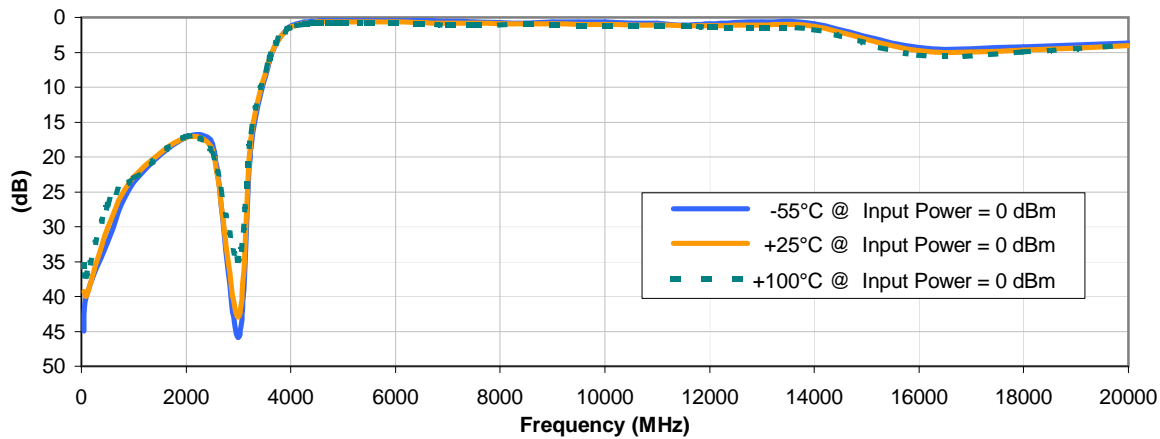


Typical Performance Curves

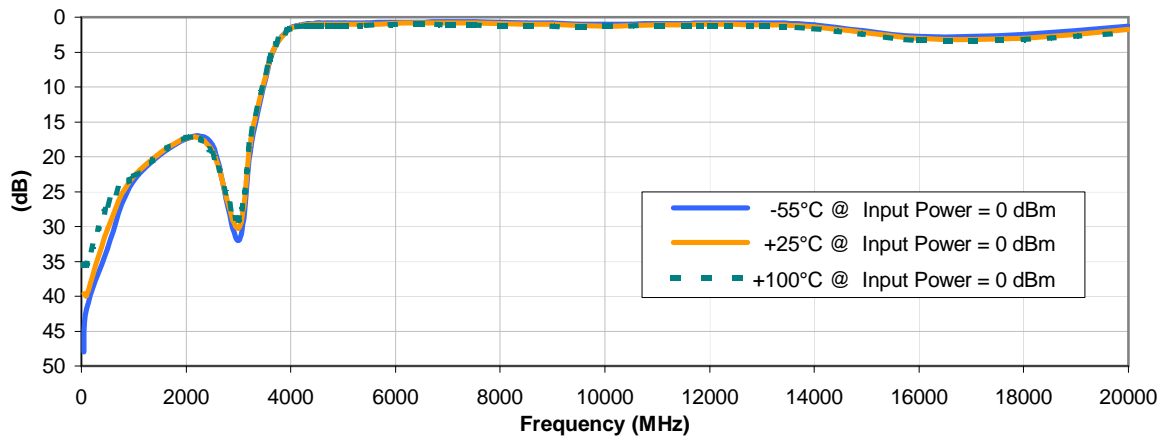
INSERTION LOSS vs. TEMPERATURE



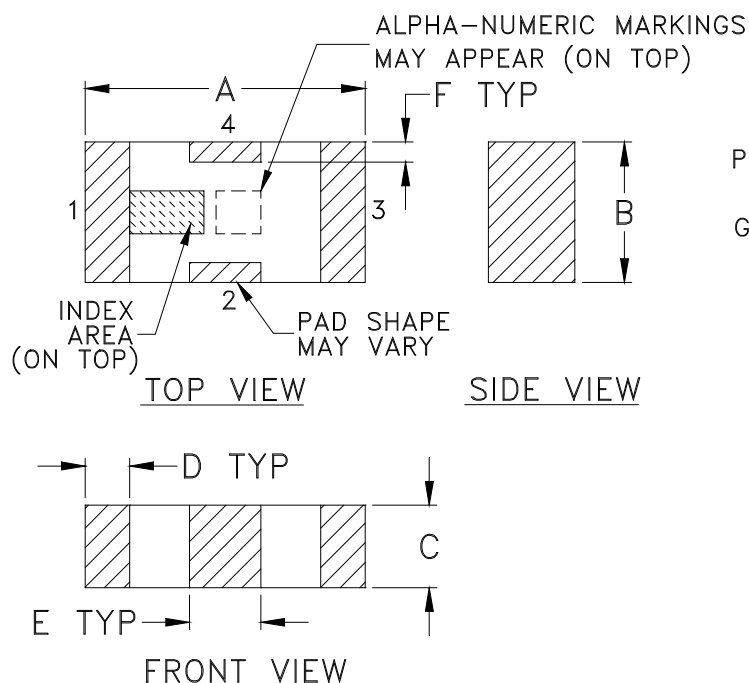
INPUT RETURN LOSS vs. TEMPERATURE



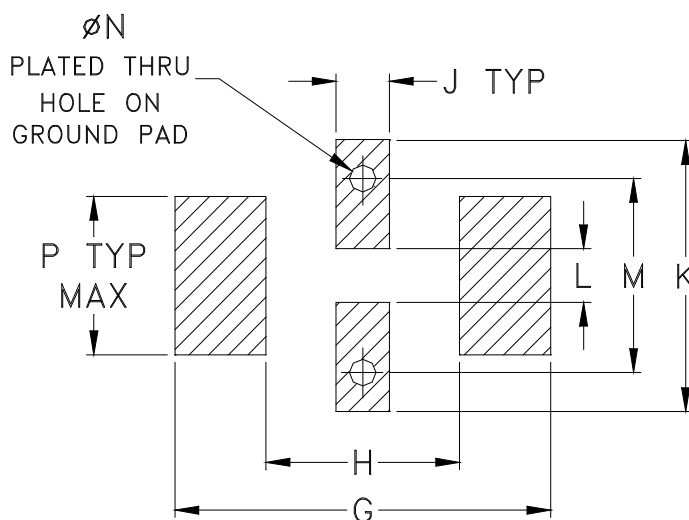
OUTPUT RETURN LOSS vs. TEMPERATURE



Outline Dimensions



PCB Land Pattern



Suggested Layout,
Tolerance to be within $\pm .002$

CASE #	A	B	C	D	E	F	G	H	J	K	L	M	N	P	WT. GRAM
FV1206	.126 (3.20)	.063 (1.60)	.037 (0.94)	.020 (0.51)	.032 (0.81)	.009 (0.23)	.169 (4.29)	.087 (2.21)	.024 (0.61)	.122 (3.10)	.024 (0.61)	.087 (2.21)	.012 (0.30)	.071 (1.80)	.020

Dimensions are in inches (mm). Tolerances: 2 Pl. $\pm .01$; 3 Pl. $\pm .005$

Notes:

- Open style, ceramic base.
- Termination finish: **as shown below or indicated on Data Sheet.**
For RoHS Case Styles: Tin plate over Nickel plate. All models, (+) suffix.
For RoHS-5 Case Styles: Tin-Lead plate. All models, no (+) suffix.



P.O. Box 350166, Brooklyn, New York 11235-0003 (718) 934-4500 Fax (718) 332-4661 For detailed performance specs & shopping online see Mini-Circuits web site



The Design Engineers Search Engine Provides ACTUAL Data Instantly From MINI-CIRCUITS At: www.minicircuits.com

RF/IF MICROWAVE COMPONENTS

Tape & Reel Packaging TR-F71



ILLUSTRATION 1

Tape Width, mm	Device Cavity Pitch, mm	Reel Size, inches	Devices per Reel	
8	4	7	Small quantity standards (see note)	20
				50
				100
				200
				500
				1000
			Standard	3000

Note: Please Consult individual model data sheet to determine device per reel availability.

Mini-Circuits carrier tape materials provide protection from ESD (Electro-Static Discharge) during handling and transportation. Tapes are static dissipative and comply with industry standards EIA-481/EIA-541.

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RF/IF MICROWAVE COMPONENTS

THIRD ANGLE PROJECTION



REVISIONS

REV	ECN No.	DESCRIPTION	DATE	DR	AUTH
OR	M88634	NEW RELEASE	08/28/03	GF	ABD
A	M102713	ADDED "...WITH SMOBC"	01/17/06	MMG	IL

SUGGESTED MOUNTING CONFIGURATION
FOR FV1206 CASE STYLE, "nx" PIN CONNECTION



- NOTES:
1. COPLANAR WAVEGUIDE PARAMETERS ARE SHOWN FOR ROGERS R04350B WITH THICKNESS .020" ± .0015".
 COPPER: 1/2 OZ. EACH SIDE.
 FOR OTHER MATERIALS TRACE WIDTH & GAP MAY NEED TO BE MODIFIED.

2. BOTTOM SIDE OF THE PCB IS CONTINUOUS GROUND PLANE.



DENOTES PCB COPPER LAYOUT WITH SMOBC
 (SOLDER MASK OVER BARE COPPER)



DENOTES COPPER LAND PATTERN FREE OF SOLDER MASK

UNLESS OTHERWISE SPECIFIED

INITIALS

DATE

DIMENSIONS ARE IN INCHES

DRAWN

GF

08/27/03

TOLERANCES ON:

CHECKED

AV

08/28/03

2 PL DECIMALS ±

APPROVED

ABD

08/28/03

3 PL DECIMALS ± .005

ANGLES ±

FRACTIONS ±



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ASHEETA1.DWG REV:A DATE:01/12/95



Mini-Circuits®

13 Neptune Avenue
 Brooklyn NY 11235

PL, nx, FV1206, LFCN/HFCN, TB-270

SIZE A	CODE IDENT 15542	DRAWING NO: 98-PL-137	REV: A
FILE: 98PL137	SCALE: 10:1	SHEET: 1 OF 1	

Evaluation Board and Circuit




TB-270

Schematic Diagram

Notes:

1. SMA Female connectors.
2. PCB Material: ROGERS R04350 or equivalent, Dielectric Constant=3.5, Thickness=.020 inch.

 **Mini-Circuits®**

All Mini-Circuits products are manufactured under exacting quality assurance and control standards, and are capable of meeting published specifications after being subjected to any or all of the following physical and environmental test.

Specification	Test/Inspection Condition	Reference/Spec
Operating Temperature	-55° to 100°C Ambient Environment	Individual Model Data Sheet
Storage Temperature	-55° to 100° C Ambient Environment	Individual Model Data Sheet
Humidity	90 to 95% RH, 240 hours, 50°C	MIL-STD-202, Method 103, Condition A, Except 50°C and end-point electrical test done within 12 hours
Solder Reflow Heat	Sn-Pb Eutetic Process: 225°C peak Pb-Free Process 245° - 250°C peak	J-STD-020, Table 4-1, 4-2 and 5-2, Figure 5-1
Solderability	10X Magnification	J-STD-002, Para 4.2.5, Test S, 95% Coverage
Vibration (High Frequency)	20g peak, 10-2000 Hz, 12 times in each of three perpendicular directions (total 36)	MIL-STD-202, Method 204, Condition D
Mechanical Shock	50g, 11 ms, 1/2-sine, 18 shocks: 3 each direction, each of 3 axes	MIL-STD-202, Method 213, Condition A